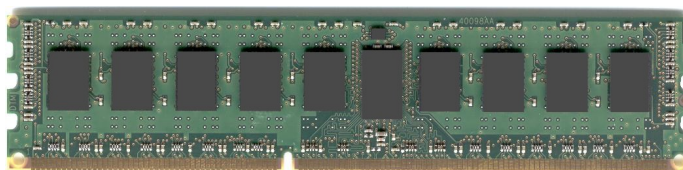


## Products in Family

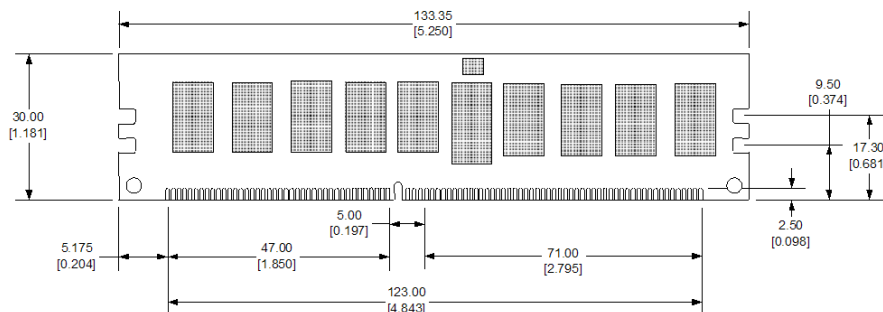
GRST3/4GB (2 x 2GB 2Rx8 DIMMs)  
GRST3/8GB (2 x 4GB 2Rx8 DIMMs)  
GRST3/16GB (2 x 8GB 2Rx4 DIMMs)



Features	Description
240-pin JEDEC-compliant DIMMs 133.35 mm wide by 30 mm high (1.181" x 5.25") Data Transfer Rate: 10.6 Gigabytes/sec Operating Voltage: 1.35V(1.28V~1.45V) & 1.5V(1.425V~1.575V) Fully RoHS Compliant Thermal Sensor  Note : 2GB DIMMs operate at 1.5V only	Each GRST3 upgrade consists of a matched pair of DDR3L-1333 Registered ECC DIMMs that conforms to JEDEC's DDR3, PC3L-10600 standard. One 2K-bit EEPROM is used for Serial Presence Detect and a combination register/PLL with Address and Command Parity is also used. A thermal sensor accurately monitors the DIMM module and can prevent exceeding the maximum operating temperature of 95C.

Dataram Product	Sun Microsystems Product	Supported in these Sun Microsystems systems:
GRST3/4GB GRST3/8GB GRST3/16GB	SE6X2A11Z SE6X2B11Z SE6X2C11Z	Oracle / Sun SPARC T3-1, T3-2, T3-4, and T3-1B Server Module

## Front view

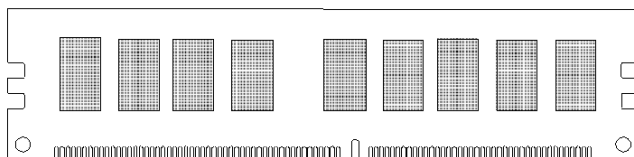


## Notes

Tolerances on all dimensions except where otherwise indicated are  $\pm 0.13$  (.005).

All dimensions are expressed in millimeters [inches]

## Back view



## Side view

